

**PATENT NUMBER**

## U.S. UTILITY Patent Application

<p>O.I.P.E.</p> <p>FA <u>332</u></p> <p>SCANNED <u>332</u></p> <p>G.A. <u>1003</u></p>	<p>PATENT DATE</p>
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APPLICATION NO. 09/893455	CONT/PRIOR D F	CLASS <del>425</del> 264	SUBCLASS 40.3	ART UNIT <del>1722</del> 1732	EXAMINER ORT72
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Akira Sugai

**TITLE**      **APPLICANTS**

Transfer molding apparatus and method for manufacturing semiconductor devices

PTO-2040  
12/89

<b>ISSUING CLASSIFICATION</b>									
<b>ORIGINAL</b>				<b>CROSS REFERENCE(S)</b>					
<b>CLASS</b>		<b>SUBCLASS</b>		<b>CLASS</b>	<b>SUBCLASS (ONE SUBCLASS PER BLOCK)</b>				
<b>INTERNATIONAL CLASSIFICATION</b>									

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	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner) (Date)		<b>NOTICE OF ALLOWANCE MAILED</b>  	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____	_____ (Primary Examiner) (Date)		<b>ISSUE FEE</b> Amount Due Date Paid	
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